1. General description

Silicon Germanium (SiGe) rectifier encapsulated in a CFP3 (SOD123W) small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

Features	Benefits				
 Low forward voltage and low Q_{rr} Extremely low leakage current Thermal stability up to 175 °C junction temperature Fast and smooth switching Low parasitic capacitance AEC-Q101 qualified 	 Excellent efficiency Extraordinary safe operating area Minimal impact on Electro-Magnetic Compatibility (EMC) allowing simplified certification 				

3. Applications

- High-efficiency power conversion
 - · Automotive LED lighting
 - Engine control unit
 - Server power supply
 - Base station power supply
- Reverse polarity protection
- OR-ing

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; square wave; f = 20 kHz; T _{sp} ≤ 167 °C		-	-	1	Α
V_R	reverse voltage	T _j = 25 °C		-	-	200	V
V _F	forward voltage	I _F = 1 A; T _j = 25 °C; pulsed	[1]	-	805	880	mV
I _R	reverse current	V _R = 200 V; T _j = 25 °C; pulsed	[1]	-	0.2	30	nA
		$V_R = 200 \text{ V; } T_j = 150 ^{\circ}\text{C; pulsed}$	[1]	-	15	150	μA

[1] Very short pulse, in order to maintain a stable junction temperature.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	1 2	K [4] A
2	Α	anode		\^
			CFP3 (SOD123W)	006aab040

6. Ordering information

Table 3. Ordering information

Type number Package					
	Name	Description	Version		
PMEG200G10ELR		plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W		

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG200G10ELR	LJ

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Attention: Stress above one of these maximum values may cause irreversible damage to the device.

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	200	V
I _F	forward current	δ = 1; $T_{sp} \le 164 ^{\circ}\text{C}$		-	1.4	А
I _{F(AV)}	average forward current	δ = 0.5; square wave; f = 20 kHz; T _{sp} ≤ 167 °C		-	1	А
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	40	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.68	W
			[2]	-	1.15	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

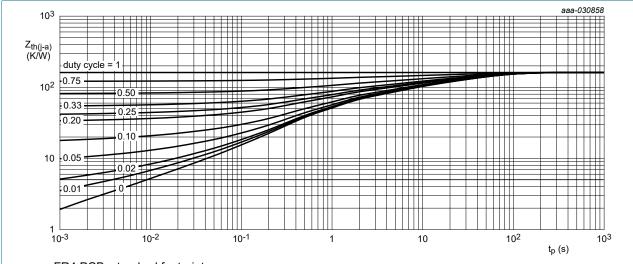
- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

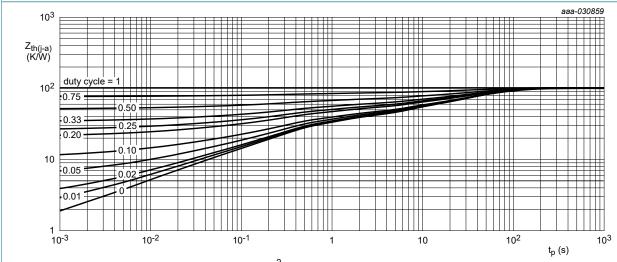
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	[1]	-	-	220	K/W
junction to ambient	junction to ambient		[2]	-	-	130	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	18	K/W

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm²

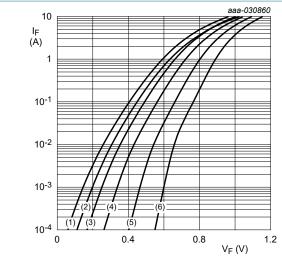
Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; pulsed; T_j = 25 °C	[1]	200	-	-	V
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C; pulsed	[1]	-	665	740	mV
		I _F = 0.5 A; T _j = 25 °C; pulsed	[1]	-	760	840	mV
		I _F = 0.7 A; T _j = 25 °C; pulsed	[1]	-	780	860	mV
		I _F = 1 A; T _j = 25 °C; pulsed	[1]	-	805	880	mV
		I _F = 1 A; T _j = -40 °C; pulsed	[1]	-	890	980	mV
		I _F = 1 A; T _j = 125 °C; pulsed	[1]	-	660	760	mV
I _R	reverse current	$V_R = 200 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	[1]	-	0.2	30	nA
		V _R = 200 V; T _j = 125 °C; pulsed	[1]	-	2.5	25	μΑ
		V _R = 200 V; T _j = 150 °C; pulsed	[1]	-	15	150	μΑ
C _d	diode capacitance	$V_R = 1 \text{ V}; f = 1 \text{ MHz}; T_j = 25 ^{\circ}\text{C}$		-	29	-	pF
		$V_R = 10 \text{ V}; f = 1 \text{ MHz}; T_j = 25 \text{ °C}$		-	12	-	pF
t _{rr}	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$; $I_R = 1 \text{ A}$; $I_{R(meas)} = 0.25 \text{ A}$; $I_j = 25 \text{ °C}$		-	17	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}$; $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $T_j = 25 \text{ °C}$		-	34	-	ns
I _{RM}	peak reverse recovery current			-	1	-	Α
Q _{rr}	reverse recovery charge			-	19	-	nC
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	885	-	mV

^[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

(1) $T_i = 175$ °C

(2) $T_i = 150 °C$

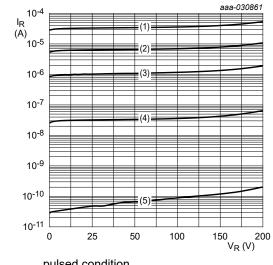
 $(3) T_i = 125 °C$

 $(4) T_i = 85 °C$

 $(5) T_{i} = 25 ^{\circ}C$

(6) $T_i = -40 \, ^{\circ}\text{C}$

Forward current as a function of forward Fig. 3. voltage; typical values



pulsed condition

(1) $T_i = 175 \, ^{\circ}C$

 $(2) T_i = 150 °C$

(3) $T_i = 125 °C$

 $(4) T_i = 85 ^{\circ}C$ $(5) T_i = 25 °C$

Fig. 4. Reverse current as a function of reverse voltage; typical values

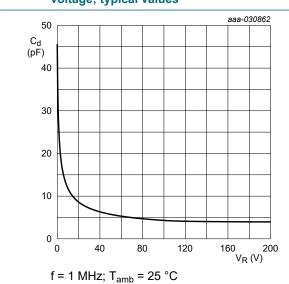
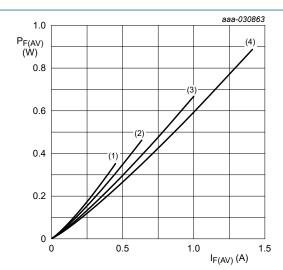


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



T_i = 175 °C

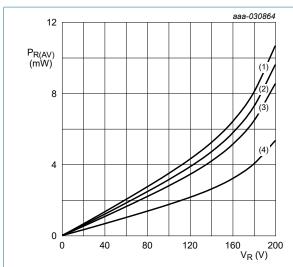
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$

(4) $\delta = 1$; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



T_j = 175 °C

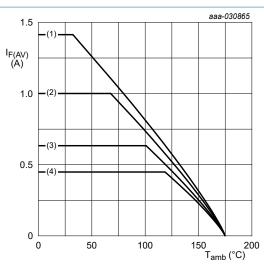
 $(1) \delta = 1$; DC

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

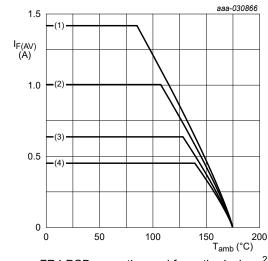
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_j = 175 \,^{\circ}C$

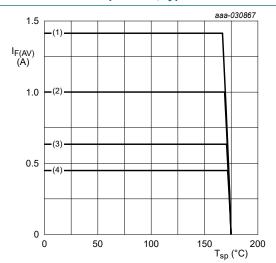
(1) $\delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$

 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

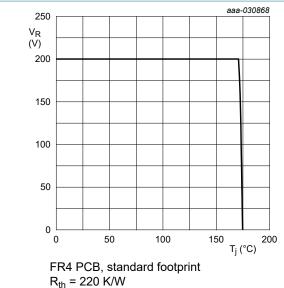
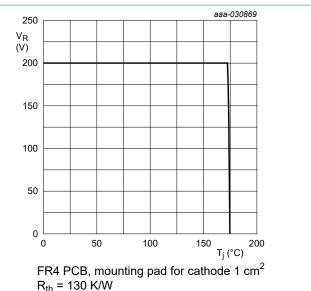


Fig. 11. Derated maximum reverse voltage as a function of junction temperature; typical values

Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values



> 150 T_j (°C)

Soldering point of cathode tab R_{th} = 18 K/W

Fig. 13. Derated maximum reverse voltage as a function of junction temperature; typical values

50

100

0

11. Test information

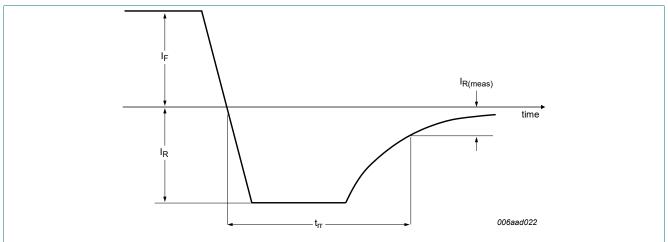


Fig. 14. Reverse recovery definition; step recovery

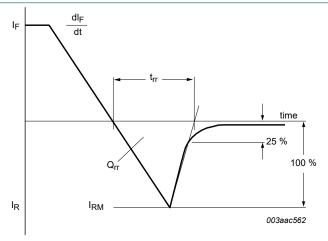


Fig. 15. Reverse recovery definition; ramp recovery

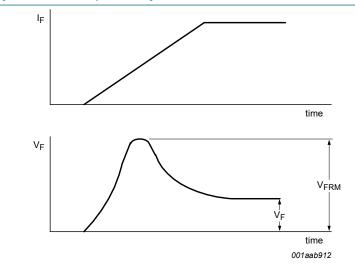
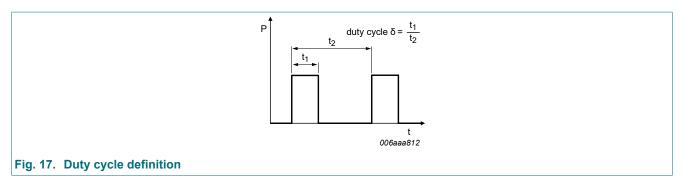


Fig. 16. Forward recovery definition



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)}=I_M\times\delta$ with I_M defined as peak current

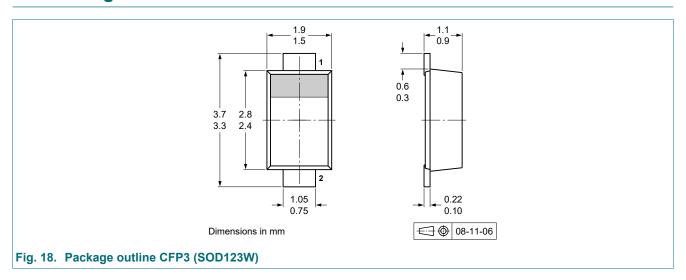
 $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$

with I_{RMS} defined as RMS current.

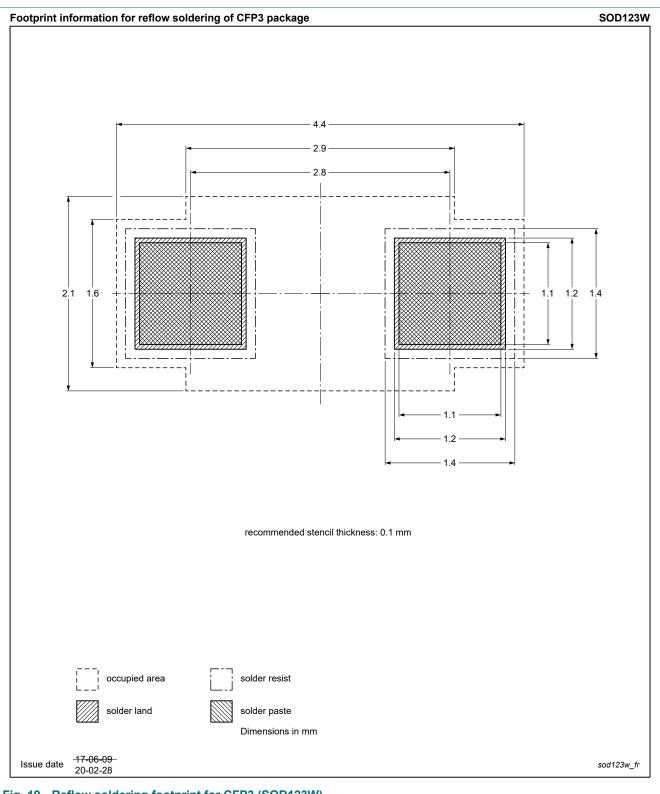
Quality information

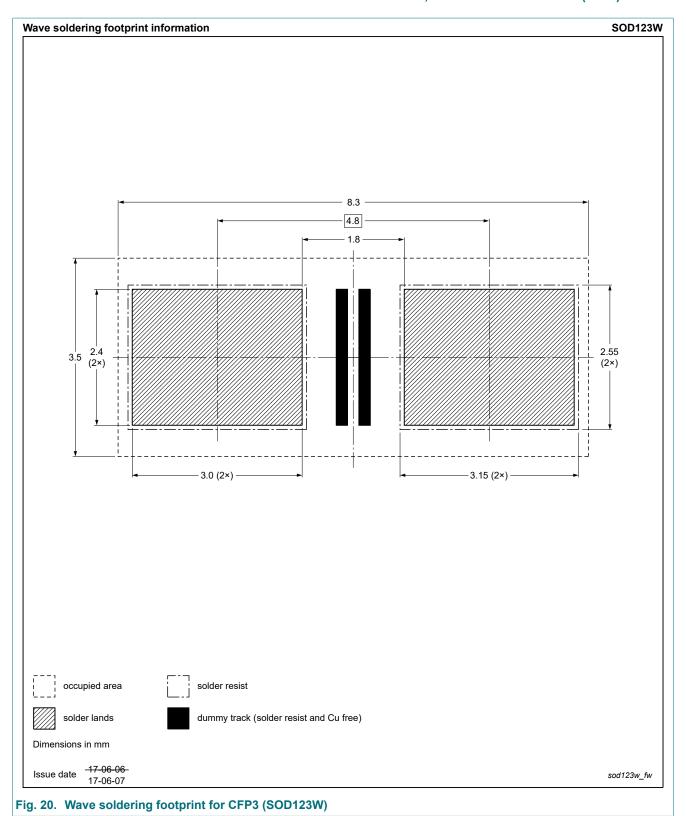
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Mounting

This device is sensitive to Electro Static Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

15. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG200G10ELR v.1	20200728	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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200 V, 1 A Silicon Germanium (SiGe) rectifier

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